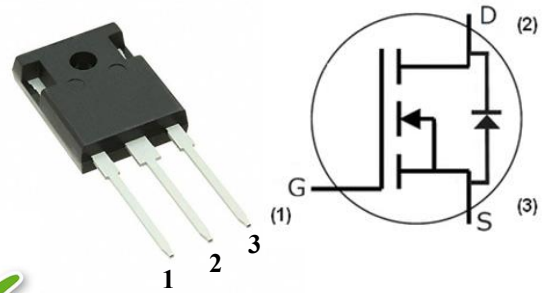


Product Summary

$V_{DS} = 650\text{ V}$
 $I_D@25^\circ\text{C} = 97\text{ A}$
 $R_{DS(ON)} = 28\text{ m}\Omega$
 AEC-Q101 in Progress



TO-247-3

Features

- High Blocking Voltage
- High Frequency Operation
- Low on-resistance
- Fast intrinsic diode with low reverse recovery

Benefits

- Higher System Efficiency
- Parallel Device Convenience without thermal runaway
- High Temperature Application
- Hard Switching & Higher Reliability
- Easy to drive

Applications

- Motor Drives
- Solar Inverters
- Onboard EV Charger
- Energy Storage
- Server
- Telecom
- SMPS
- Uninterruptable power supplies

Maximum Ratings ($T_C=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Test conditions	Value	Unit
Drain - Source Voltage	V_{DSmax}	$V_{GS}=0\text{V}, I_D=100\mu\text{A}$	650	V
Gate - Source Voltage (dynamic)	V_{GSmax}	AC ($f>1\text{ Hz}$)	-10 / +25	V
Gate - Source Voltage (static)	V_{GSop}	static	-5 / +20	V
Continuous Drain Current	I_D	$V_{GS} = 20\text{V}, T_C=25^\circ\text{C}$	97	A
		$V_{GS} = 20\text{V}, T_C=100^\circ\text{C}$	68	
Pulsed Drain Current	$I_{D(pulse)}$	$T_C=25^\circ\text{C}$	226	A
Short Circuit Capability	t_{SC}	$V_{DD}=400\text{V}, V_{GS}=20\text{V}$	10	μS
Short Circuit Capability	I_{DS}	$V_{DD}=400\text{V}, V_{GS}=20\text{V}$	400	A
Total power dissipation	P_D	$T_C=25^\circ\text{C}$	375	W
Operating Junction Temperature	T_J		-55 to 175	$^\circ\text{C}$
Storage Temperature	T_{STG}		-55 to 175	$^\circ\text{C}$

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Electrical Characteristics (T_C=25°C unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 100μA	650			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 10mA	2.0	3	4.0	V
		V _{DS} = V _{GS} , I _D = 10mA, T _J = 150°C		2.2		V
		V _{DS} = V _{GS} , I _D = 10mA, T _J = 175°C		2		V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 650V, V _{GS} = 0V	0	1	100	μA
Gate-Source Leakage Current	I _{GSS}	V _{GS} = 20V, V _{DS} = 0V	0	10	200	nA
Gate-Source Leakage Current	I _{GSS}	V _{GS} = -5V, V _{DS} = 0V	-200	-10	0	nA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 15V, I _D = 40 A		49		mΩ
		V _{GS} = 15V, I _D = 40 A, T _J = 150°C		40		
		V _{GS} = 15V, I _D = 40 A, T _J = 175°C		41		
		V _{GS} = 20V, I _D = 40 A		28	36	
		V _{GS} = 20V, I _D = 40 A, T _J = 150°C		32		
		V _{GS} = 20V, I _D = 40 A, T _J = 175°C		34		
Transconductance	g _{fs}	V _{DS} = 20V, I _D = 40 A,		21		S
		V _{DS} = 20V, I _D = 40 A, T _J = 150°C		20		
		V _{DS} = 20V, I _D = 40 A, T _J = 175°C		19		
Input capacitance	C _{iSS}	V _{DS} = 400V, V _{GS} = 0V f = 1MHz		3000		pF
Output capacitance	C _{oSS}			290		
Reverse transfer capacitance	C _{rSS}			12		
C _{oSS} Stored Energy	E _{oSS}			28		
Total gate charge	Q _g	V _{DS} = 400V, V _{GS} = -5V / 20V I _D = 40 A,		152		nC
Gate-source charge	Q _{gs}			48		
Gate-drain charge	Q _{gd}			60		
Internal gate input resistance	R _{g(int)}	f = 1MHz, I _D = 0A		2.0		Ω
Turn-On Switching Energy	E _{ON}	V _{DS} = 400 V, V _{GS} = -5V/20V, I _D = 40A, R _{G(ext)} = 2Ω, L=200μH		209		μJ
Turn-Off Switching Energy	E _{OFF}			39		
Turn-On Delay Time	t _{d(on)}			13		ns
Rise Time	t _r			30		
Turn-Off Delay Time	t _{d(off)}			29		
Fall Time	t _f			6		
Avalanche Capability	E _{AS}	V _{DD} = 100V, V _{GS} =20V, L=1mH		544		mJ
Avalanche Capability	I _{AV}			33		A

Reverse Diode Characteristics ($T_C=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Diode Forward Voltage	V_{SD}	$V_{GS} = -5\text{V}, I_{SD} = 20\text{A},$		4.0		V
		$V_{GS} = -5\text{V}, I_{SD} = 20\text{A},$ $T_J = 150^\circ\text{C}$		3.6		
		$V_{GS} = -5\text{V}, I_{SD} = 20\text{A},$ $T_J = 175^\circ\text{C}$		3.5		
Continuous Diode Forward Current	I_S	$V_{GS} = -5\text{V}$		71		A
Reverse Recovery time	t_{rr}	$V_{GS} = -5\text{V}, I_{SD} = 40\text{A},$ $V_R = 400\text{V}, \text{dif}/\text{dt} = 4000 \text{ A}/\mu\text{s}$		24		ns
Reverse Recovery Charge	Q_{rr}			345		nC
Peak Reverse Recovery Current	I_{rrm}			23		A

Thermal Characteristics

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Thermal Resistance (per device)	$R_{th(j-c)}$	junction-case		0.32	0.4	$^\circ\text{C}/\text{W}$

Typical Performance

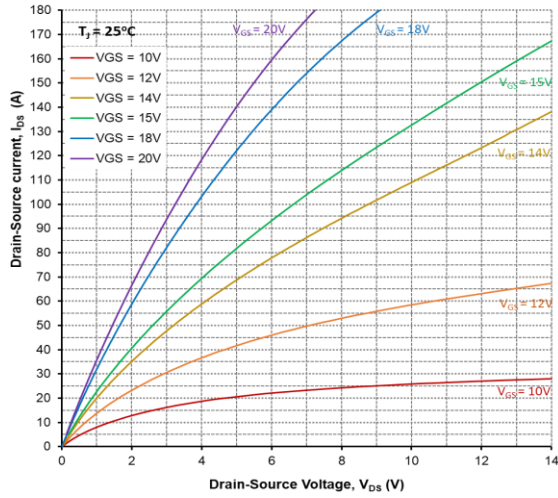


Figure 1. Output Characteristics, $T_J = 25^\circ\text{C}$

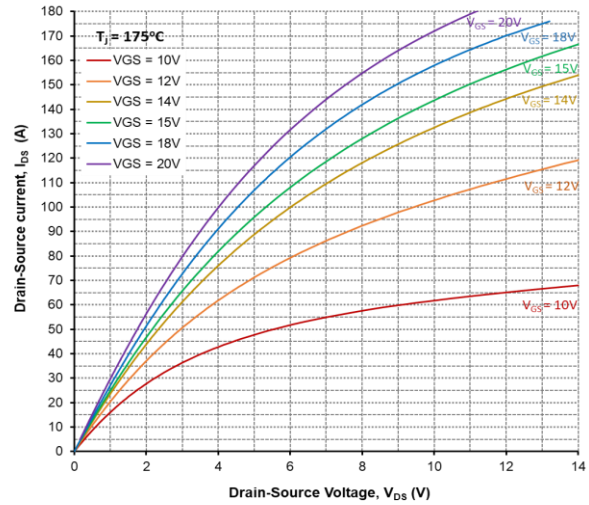


Figure 2. Output Characteristics, $T_J = 175^\circ\text{C}$

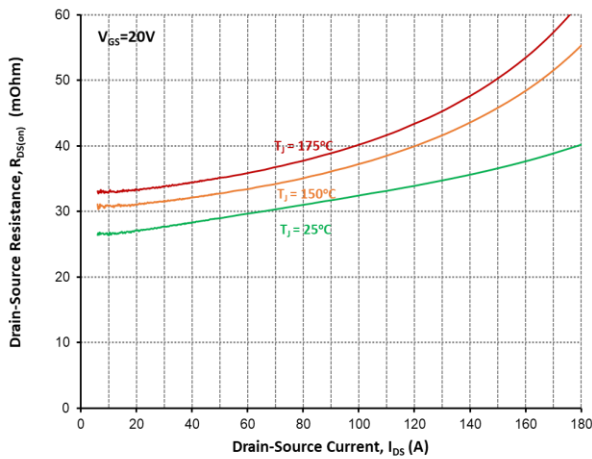


Figure 3. On-Resistance vs. Drain Current For Various Temperatures

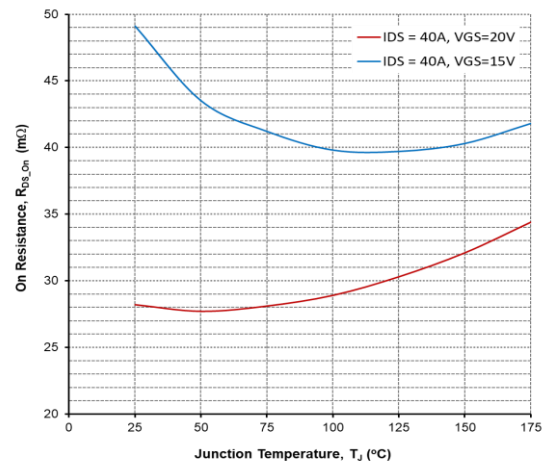


Figure 4. On-Resistance vs. Temperature

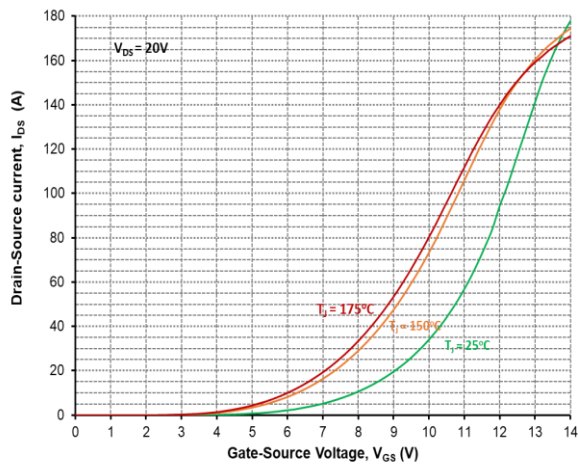


Figure 5. Transfer Characteristic For Various Junction Temperatures

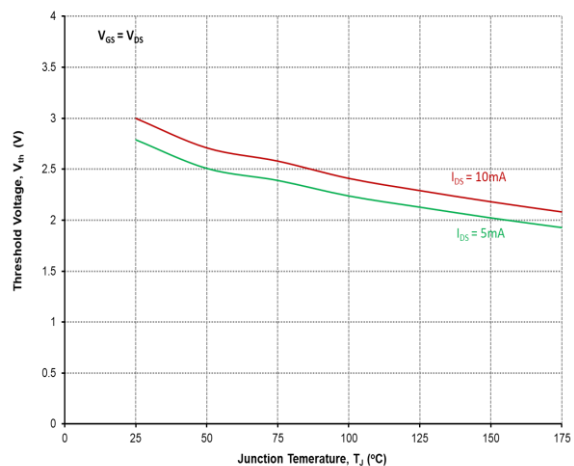


Figure 6. Threshold Voltage vs. Temperature

Typical Performance

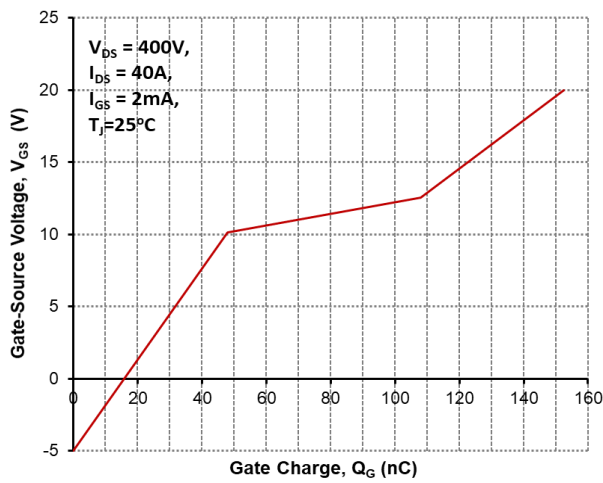


Figure 7. Gate Charge Characteristics

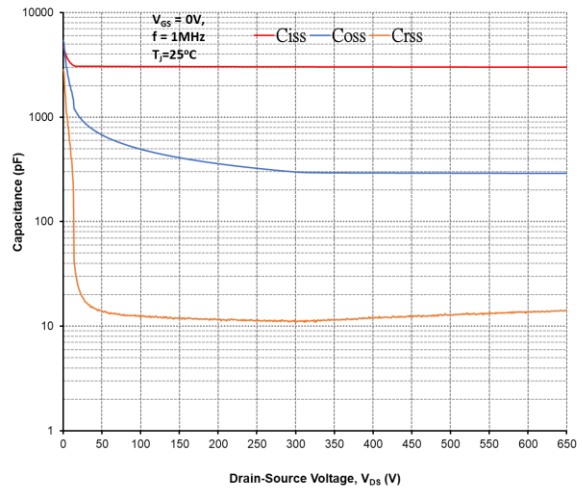


Figure 8. Capacitances vs. Drain-Source Voltage (0-650V)

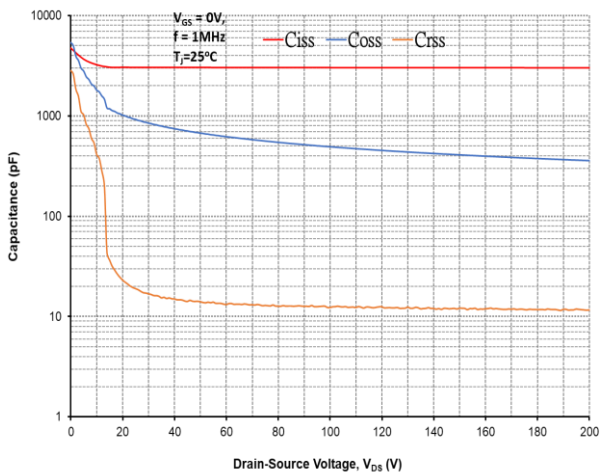


Figure 9. Capacitances vs. Drain-Source Voltage (0-200V)

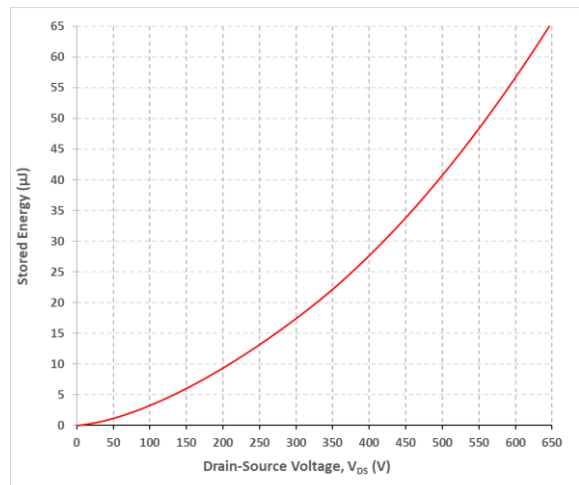


Figure 10. Output Capacitor Stored Energy

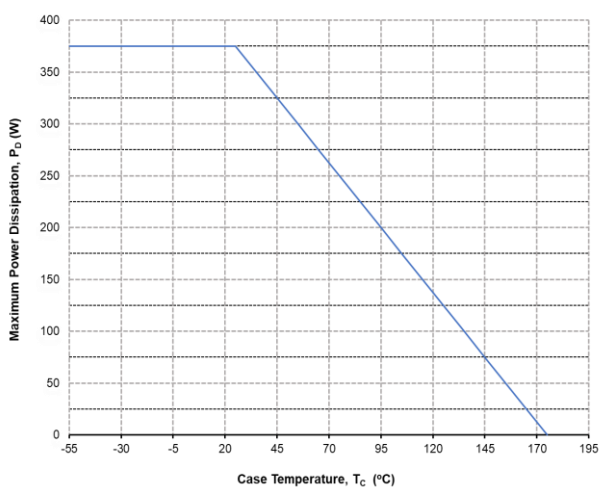


Figure 11. Maximum Power Dissipation Derating vs. Case Temperature

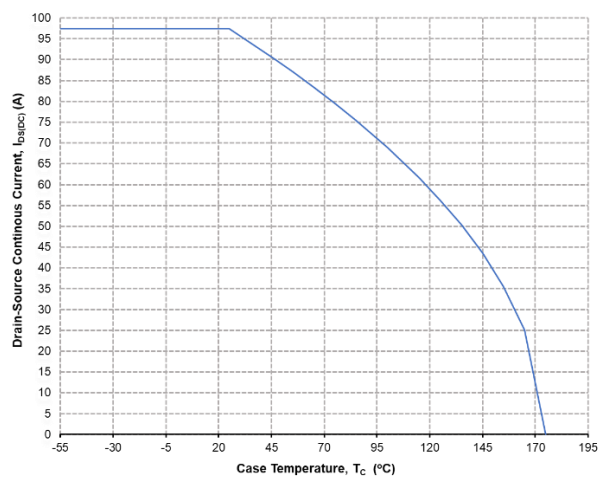


Figure 12. Continuous Drain Current Derating vs. Case Temperature

Typical Performance

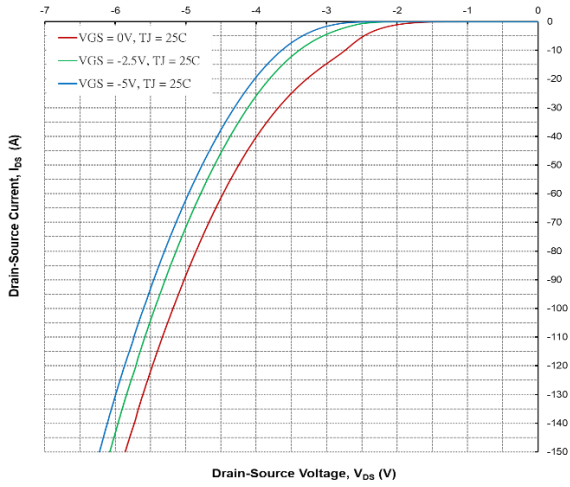


Figure 13. Body Diode Characteristics @ 25°C

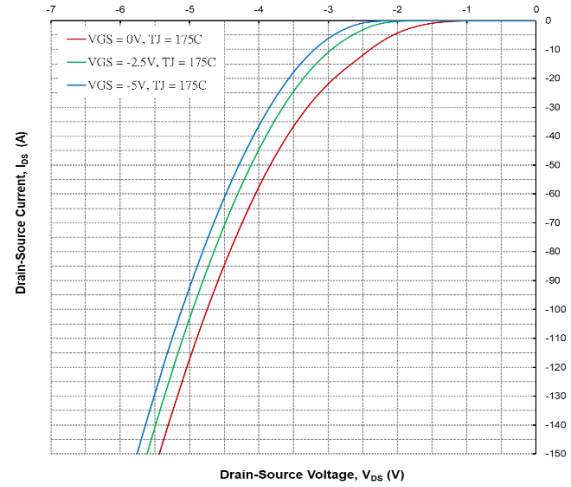


Figure 14. Body Diode Characteristics @ 175°C

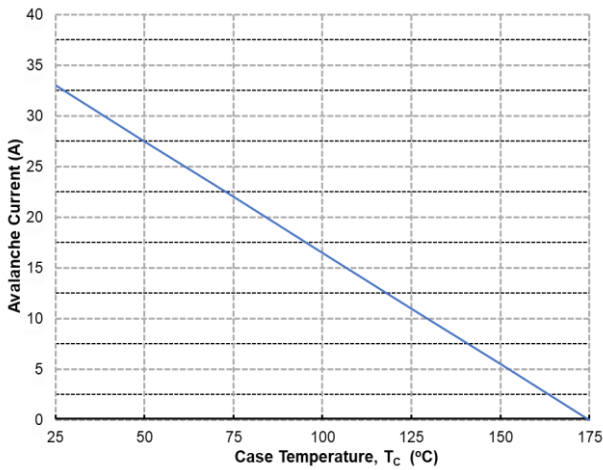


Figure 15. Single Avalanche vs. Temperature

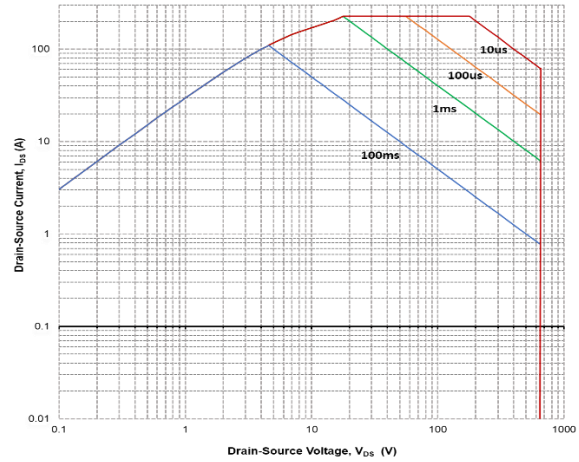
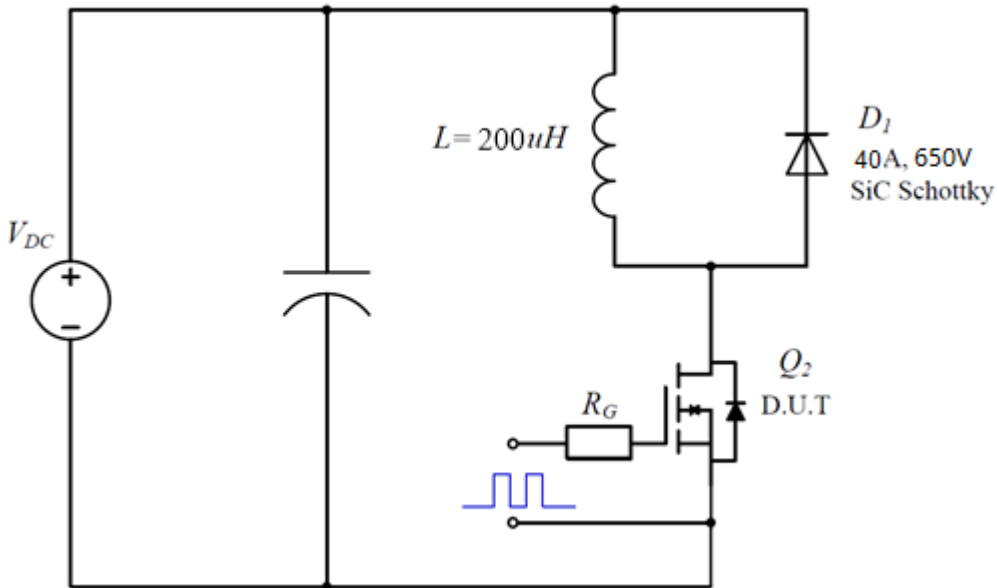
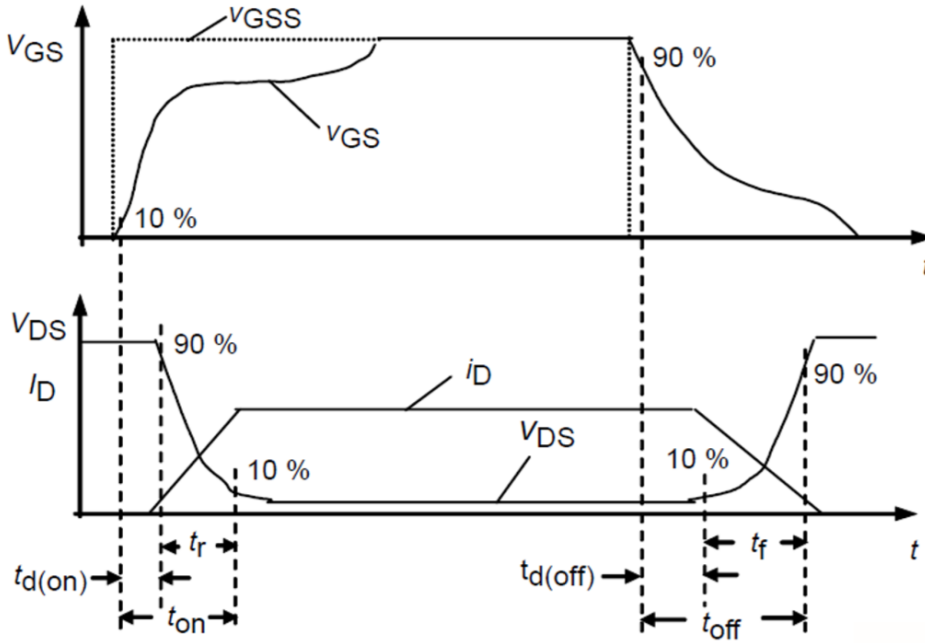


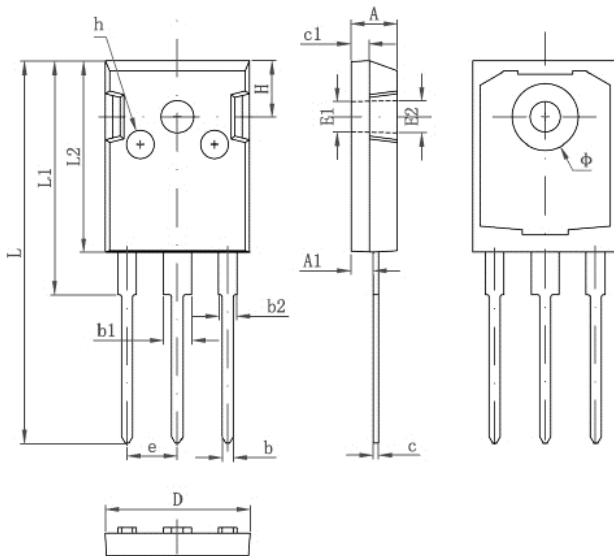
Figure 16. Safe Operating Area

Switching Times Definition and Test Circuit



Package Dimensions

(TO-247-3 Package)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	4.850	5.150	0.191	0.200
A1	2.200	2.600	0.087	0.102
b	1.000	1.400	0.039	0.055
b1	2.800	3.200	0.110	0.126
b2	1.800	2.200	0.071	0.087
c	0.500	0.700	0.020	0.028
c1	1.900	2.100	0.075	0.083
D	15.450	15.750	0.608	0.620
E1	3.500 REF		0.138 REF	
E2	3.600 REF		0.142 REF	
L	40.900	41.300	1.610	1.626
L1	24.800	25.100	0.976	0.988
L2	20.300	20.600	0.799	0.811
Φ	7.100	7.300	0.280	0.287
e	5.450 TYP		0.215 TYP	
H	5.980 REF		0.235 REF	
h	0.000	0.300	0.000	0.012